12-bit, serial IN, parallel OUT driver BU2090 / BU2090F / BU2090FS / BU2092 / BU2092F / BU2092FV

The BU2090, BU2090F, BU2090FS, BU2092F, BU2092F, and BU2092FV are 12-bit serial input, parallel output drivers.

For the BU2090 / F / FS, data input is shifted to the 12-bit internal shift register on the rising edge of a clock pulse. On the falling edge of the pulse, if the DATA pin is HIGH, the data in the shift register is output in parallel to Q0 to Q11.

For the BU2092 / F / FV, shift data read at the rising edge of CLOCK is output in parallel to Q0 to Q11 at the rising edge of LCK. These ICs also have an OE pin, which when HIGH, forces data to be output, regardless of the shift data state.

Applications

Radio cassette players, telephones, compact audio systems, car stereos, and others

Features

- 1) Low power dissipation.
- 2) Operating voltages ranging from 2.7 to 5.5V.
- 3) Output is Nch open drain.
- 4) High output withstand voltage of + 25V.

- 5) Diverse variety of packages. BU2090 / F / FS: DIP16, SOP16, SSOP-A16 BU2092 / F / FV: DIP18, SOP18, SSOP-A18 (plastic molds)
- High drive capability; direct lighting of green LED possible.



•Absolute maximum ratings (Ta = 25°C)

(BU2090 / F / FS, BU2092 / F / FV)	
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Pa	rameter	Symbol	Limits	Unit
Power suppl	y voltage	Vdd	- 0.3 ~ + 7.0	V
Power BU2090 / F / FS		Pd	1000 (DIP), 300 (SOP), 500 (SSOP)*1	mW
dissipation	BU2092 / F / FV	Fu	1050 (DIP), 450 (SOP), 400 (SSOP)*1	
Power	BU2090 / F / FS	Pd	500 (SOP)*2, 650 (SSOP)*3	mW
dissipation	BU2092 / F / FV	Pu	500 (SOP)*2, 650 (SSOP)*4	
Operating te	mperature	Topr	– 25 ~ + 75	°C
Storage tem	Storage temperature		- 55 ~ + 125	°C
Input voltage)	Vin	Vss-0.3 ~ Vdd + 0.3	V
Output volta	ge	Vo	Vss ~ 25.0	V

*1 Unmounted

*2 When mounted on a glass epoxy board of 50mm \times 50mm \times 1.6mm

*3 When mounted on a glass epoxy board of 90mm \times 50mm \times 1.6mm

*4 When mounted on a glass epoxy board of 70mm \times 70mm \times 1.6mm

Recommended operating conditions

Parameter	Symbol	Limits	Unit
Power supply voltage	Vdd	2.7 ~ 5.5	V

Standard ICs

Block diagram



Standard ICs

Pin descriptions

	Pin No.		Pin name	Function		
BU2090 / F / FS	BU2092 / F	BU2092 / FV	Pin name	Function		
1	1	1	Vss	GND		
2	2	2	DATA	Serial data input		
3	3	3	CLOCK	Data shift clock input		
_	4	4	LCK	Data latch clock input		
4	5	5	Q0	Parallel data output		
5	6	6	Q1	Parallel data output		
6	7	7	Q2	Parallel data output		
7	8	8	Q3	Parallel data output		
8	9	9	Q4	Parallel data output		
9	10	10	Q5	Parallel data output		
10	11	11	Q6	Parallel data output		
_	—	12	N.C.	Not connected		
_	—	13	N.C.	Not connected		
11	12	14	Q7	Parallel data output		
12	13	15	Q8	Parallel data output		
13	14	16	Q9	Parallel data output		
14	15	17	Q10	Parallel data output		
15	16	18	Q11	Parallel data output		
_	17	19	ŌĒ	Output Enable		
16	18	20	Vdd	Power supply		



Electrical characteristics (Ta = 25°C)

DC characteristics (unless otherwise noted, Ta = 25°C, Vss = 0V)

Parameter	Symbol	Min.	Тур.	Max.	Unit	Vdd	Conditions	
	Mari	3.5	—	—	v	5		
Input high level voltage	Vih	2.5	—	—	v	3		
	Ma	—	_	1.5	V	5		
Input low level voltage	VIL	—	_	0.4	v	3		
Output low level voltage	Vol	—	—	2.0	V	5	IoL = 20mA	
Output low level voltage		—	—	1.0		3	IoL = 5mA	
"H" output disable current	Іодн	—	—	10.0	μA	5	Vo = 25.0V	
"L" output disable current	lozl	—	—	- 5.0	μA	5	Vo = 0V	
Current dissinction		—	_	5.0		5	VIN = VSS OF VDD	
Current dissipation	lod	—	—	3.0	μA	3	OUTPUT: OPEN	

BU2090 / F / FS switching characteristics (unless otherwise noted, Ta = 25°C, Vss = 0V)

Parameter	Symbol	Min.	Тур.	Max.	Unit	Vdd	Conditions
Minimum clock pulse width	tw	500	—	—	20	5	
	tw	1000	—	_	ns	3	
Data shift setup time	tou	200	—		ns -	5	
	ts∪	300	_			3	
Data shift hold time	tн	200	_		ns	5	
	LH	400	_	_		3	
Data latch setup time	t lsuh	50		_	ns	5	
·		100	—			3	
Data latch hold time		250	_		20	5	_
	tlнн	500	_		ns	3	
Data latch "L" setup time	t	200	—		20	5	_
	t LSUL	400	—	—	ns	3	
Data latch "L" hold time	4	250	—	—	20	5	_
	tlнL	500	_	_	ns	3	

ONot designed for radiation resistance.

BU2090 / F / FS switching characteristics measurement conditions



Parameter	Symbol	Min.	Тур.	Max.	Unit	Vdd	Conditions
		—	55	_	20	5	RL = 5kΩ
Transmission delay time	tplz (LCK)	_	90	_	ns	3	C∟ = 10pF
(LCK to OUTPUT QX)			50			5	RL = 5kΩ
	t PZL (LCK)	_	115	_	ns	3	C∟ = 10pF
		_	45			5	R∟ = 5kΩ
Output disable time	t PLZ		70	_	ns	3	C∟ = 10pF
(OE to OUTPUT QX)			35		ns	5	RL = 5kΩ
	t PZL		80			3	C∟ = 10pF
Minimum clock pulse width	A	500	_	_	ns	5	
Minimum clock pulse width	tw	1000				3	
Minimum latah pulas width	tw (LCK)	500	—	—		5	
Minimum latch pulse width		1000	_	_	ns	3	
Setup time	4-	200	_	_	20	5	
(LCK to CLOCK)	ts	400	_	_	ns	3	
Setup time		200				5	
(DATA to CLOCK)	ts∪	400	_	_	ns	3	
Hold time	4	200			20	5	_
(CLOCK to DATA)	tн	400	_	_	ns	3	

 \bigcirc Not designed for radiation resistance.

BU2092 / F / FV switching characteristics measurement conditions



Fig.2

Truth table

BU2092 / F / FV

INPUT			FUNCTION	
CLOCK	DATA	LCK	OE	FUNCTION
×	×	×	Н	Output (Q0 to Q11) disabled
×	×	×	L	Output (Q0 to Q11) enabled
1	L	×	×	First cell of the shift register stores the LOW. Other cells, respectively, store data from the preceding cells or other prior data. (Output state is HOLD.)
Ŀ	Н	×	×	First cell of the shift register stores the HIGH. Other cells, respectively, store data from the preceding cells or other prior data. (Storage state and output state are HOLD.)
7	×	×	×	No change in shift register.
×	×		×	Contents of shift register are stored in storage register.
×	×	7_	×	No change in shift register.

Q0 to Q11 output for the BU2090 / F / FS and BU2092 / F / FV is Nch open drain output. When the shift register transfer data is LOW,

the corresponding output FET is ON (continuous state). When the transfer data is HIGH, the output FET is OFF (discontinuous).

Input / output circuit

BU209	BU2090 / F / FS BU2092 / F BU2092FV				2092FV	BU2090 / F / FS BU2092 / F				BU2092FV		
Pin No.	2, 3	Pin No.	2, 3, 4, 17	Pin No.	2, 3, 4, 19	Pin No.	4, 5, 6, 7, 8, 9 10, 11, 12, 13 14, 15	Pin No.	5, 6, 7, 8, 9, 10, 11, 12, 13 14, 15, 16	Pin No.	5, 6, 7, 8, 9, 10, 11, 14, 15 16, 17, 18	
	Voc G	ND (Vss)	VDD				_		GND (Vss)			

•Circuit operation

The logic of the DATA pin is sent to the 12-bit shift register on the rising edge of the CLOCK pulse. Subsequently, it is shifted from Q0 to Q11 for every clock rising edge.

For the BU2090 / F / FS

When the DATA pin is LOW on the CLOCK falling edge, the data does not change its output state. It is only shifted in the internal shift register. However, when the DATA pin is HIGH, the content of the 12-bit shift register is latched and is output to the corresponding Q0 to Q11.



Note 2) Pull-up resistance is connected to the output pin.

Fig.3 Operation timing chart



For the BU2092 / F / FV

The content of the 12-bit shift register is stored in the 12-bit storage register at the rising edge of LCK, and is output to the corresponding Q0 to Q11. When OE is HIGH, regardless of the content of the storage register, the output FET turns OFF and enters a HIGH (discontinuous) state.



Fig.4 Operation timing chart







BU2092 / F / (FV)





BU2090 / F / FS

Electrical characteristic curves







Fig.8 BU2092 / F / FV thermal derating characteristics







External dimensions (Units: mm)



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